TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT process)

# 2SC3265

# Low Frequency Power Amplifier Applications **Power Switching Applications**

High DC current gain:  $h_{FE(1)} = 100 \text{ to } 320$ Low saturation voltage: VCE (sat) = 0.4 V (max) $(I_C = 500 \text{ mA}, I_B = 20 \text{ mA})$ 

Complementary to 2SA1298

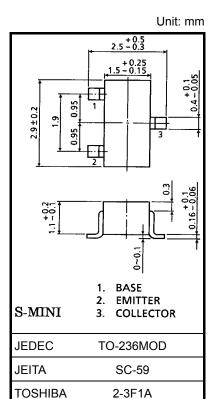
## Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	$V_{CBO}$	30	V
Collector-emitter voltage	$V_{CEO}$	25	V
Emitter-base voltage	$V_{EBO}$	5	V
Collector current	IC	800	mA
Base current	ΙΒ	160	mA
Collector power dissipation	PC	200	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling

Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



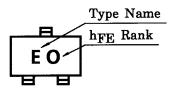
Weight: 0.012 g (typ.)

# **Electrical Characteristics (Ta = 25°C)**

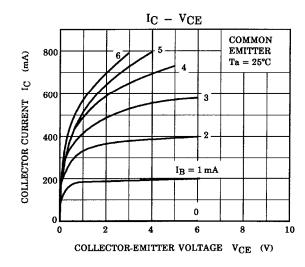
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 30 V, I <sub>E</sub> = 0	_	_	0.1	μА
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 5 V, I <sub>C</sub> = 0	_	_	0.1	μА
Collector-emitter breakdown voltage	V (BR) CEO	$I_C = 10 \text{ mA}, I_B = 0$	25	_	_	V
Emitter-base breakdown voltage	V (BR) EBO	$I_E = 0.1 \text{ mA}, I_C = 0$	5	_	_	V
DC current gain	h <sub>FE (1)</sub> (Note)	V <sub>CE</sub> = 1 V, I <sub>C</sub> = 100 mA	100	_	320	
	h <sub>FE (2)</sub>	V <sub>CE</sub> = 1 V, I <sub>C</sub> = 800 mA	40	_	_	
Collector-emitter saturation voltage	V <sub>CE</sub> (sat)	$I_C = 500 \text{ mA}, I_B = 20 \text{ mA}$	_	_	0.4	V
Base-emitter voltage	$V_{BE}$	V <sub>CE</sub> = 1 V, I <sub>C</sub> = 10 mA	0.5	_	0.8	V
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 5 V, I <sub>C</sub> = 10 mA	_	120	_	MHz
Collector output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1 MHz	_	13	_	pF

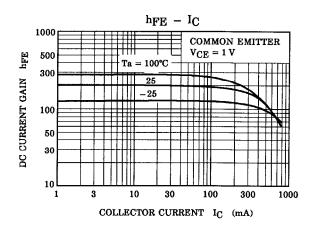
Note: hFE (1) classification O: 100 to 200, Y: 160 to 320

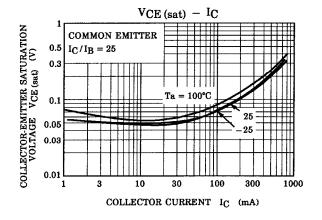
### Marking

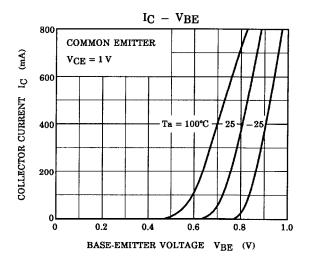


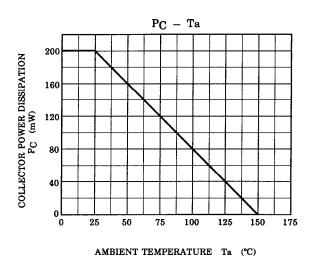
Start of commercial production 1982-10











2014-03-01

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